SKiiP 24AC12T4V1



3-phase bridge inverter

SKiiP 24AC12T4V1

Target Data

Features

- Trench 4 IGBT's
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised file no. E63532

Typical Applications

Absolute Maximum Ratings T _c = 25 °C, unless otherwise specified							
Symbol	Symbol Conditions		Values	Units			
IGBT							
V _{CES}	T _j = 25 °C		1200	V			
I _C	T _j = 175 °C	T _c = 25 °C	56	А			
		T _c = 70 °C	45	А			
I _{CRM}	$I_{CRM} = 3 x I_{Cnom}$		105	А			
V_{GES}			±20	V			
t _{psc}	V_{CC} = 600 V; $V_{GE} \le 20$ V; VCES < 1200 V	T _j = 150 °C	10	μs			
Inverse Diode							
I _F	T _j = 175 °C	T _c = 25 °C	41	А			
		T _c = 70 °C	33	А			
I _{FRM}	$I_{CRM} = 3 x I_{Cnom}$		105	А			
I _{FSM}	t _p = 10 ms; sin.	T _j = 150 °C	165	А			
Module				•			
I _{t(RMS)}			100	А			
T _{vj}			-40+175	°C			
T _{stg}			-40+125	°C			
V _{isol}	AC, 1 min.		2500	V			

Characteristics $T_c =$			25 $^\circ\text{C},$ unless otherwise specified			
Symbol	Conditions		min.	typ.	max.	Units
IGBT						
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = mA$		5	5,8	6,5	V
I _{CES}	$V_{GE} = V, V_{CE} = V_{CES}$	T _j = °C				mA
V _{CE0}		T _j = 25 °C		1,1	1,3	V
		T _j = 150 °C		1	1,2	V
r _{CE}	V _{GE} = 15 V	T _j = 25°C		22	22	mΩ
		T _j = 150°C		36	36	mΩ
V _{CE(sat)}	I _{Cnom} = 35 A, V _{GE} = 15 V			1,85	2,05	V
		T _j = 150°C _{chiplev.}		2,25	2,45	V
C _{ies}						nF
C _{oes}	V_{CE} = , V_{GE} = V	f = MHz				nF
C _{res}						nF
R _{Gint}	T _j = 25 °C			0		Ω
t _{d(on)}	_					ns
t _r	R _{Gon} =	V _{CC} = 600V				ns
E _{on}	D -	I _{Cnom} = 35A		4,2		mJ
t _{d(off)} t _f	R _{Goff} =	T _j = 150 °C V _{GE} = ±15V				ns ns
ч Е _{off}		GE - 10 V		2,8		mJ
R _{th(j-s)}	per IGBT	<u> </u>		0,8		K/W



AC

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3-phase bridge inverter

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	Characteristics						
	Symbol	Conditions		min.	typ.	max.	Units
		Inverse Diode					
L	$V_F = V_{EC}$	I _{Fnom} = 35 A; V _{GE} = 0 V	T _j = 25 °C _{chiplev.}		2,3	2,6	V
L			T _j = 150 °C _{chiplev.}		2,3	2,6	V
L	V _{F0}		T _j = 25 °C		1,3	1,5	V
L			T _j = 150 °C		0,9	1,1	V
L	r _F		T _j = 25 °C		29	31	mΩ
			T _j = 150 °C		40	43	mΩ
	I _{RRM}	I _{Fnom} = 35 A	T _j = 150 °C				А
	Q _{rr}						μC
	Err	$V_{GE} = \pm 15V$			2,63		mJ
	R _{th(j-s)}	per diode			1,37		K/W
	M _s	to heat sink		2		2,5	Nm
	w				65		g
	Temperature sensor						
	R _{ts}	3%, Tr=25°C			1000		Ω
	R _{ts}	3%, Tr=100°C			1670		Ω

Target Data

Features

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- UL recognised file no. E63532

Typical Applications

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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AC

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